



Test Research, Inc. (TRI), a leading test and inspection systems provider for the electronics manufacturing industry, returns to productronica in 2015 with a powerful and cost-effective product lineup that encompasses a full range of solutions for inspecting and testing PCB assemblies. Test Research, Inc. invites you to visit **Stall 320 in Hall A2 on November 10-13 at the Munich Trade Fair Centre** to view on-site demonstrations of the following systems:

AOI



NEW!

TR7700Q 3D AOI

- Stop&Go Inline 3D AOI
- Quad DLP 3D Technology
- Micro Component Ready (0250125mm)
- 20 mm Adaptive 3D Range

TR7500 SIII 3D 3D AOI

- Leading 3D AOI Speed
- Total 2D + 3D Coverage
- 5 Color Cameras
- Automotive + HDI Applications



TR7700 SII Plus Hybrid AOI

- Unique Hybrid AOI
- Stop& Go + Dynamic Imaging for Top Speed on any PCB
- Foreign Mat. Inspection

ICT



NEW!

TR5001 SII INLINE ICT

- Multi-core Parallel ICT
- SafeDrive Per-pin Protection
- Fast Easy Programming
- New Software UI!

TR5001T SII TINY ICT

- Most Powerful TINY ICT
- Parallel Testing
- Fast Programming
- New Software UI!



SPI



NEW!

TR7007QI 3D SPI

- Stop&Go Inline 3D SPI
- Quad DLP 3D Technology
- Ultra-High Accuracy
- SmartWarp Compensation

TR7007 SII Plus 3D SPI

- Ultimate 3D SPI Solution
- Industry Leading Inspection Speed
- High Precision and Accuracy
- Closed Loop Integration



AXI

TR7600 SII with CT 3D AXI

- High performance Inline 3D X-ray
- Planar CT Upgrade
- Up to 900x460 mm PCB
- BGA, LGA, PoP, PTH, QFN inspection

NEW!



YMS 4.0

- Defect Image Analysis and Reporting
- Intelligent Line Management Solution
- Integrated SPI, AOI, AXI & ICT Dashboard
- Remote SPC Analysis and Control
- Industry 4.0 Quality Improvement

